

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Shinsuke YANO</td> <td>11/19/2012</td> </tr> <tr> <td>Takami HIRAI</td> <td>11/23/2012</td> </tr> <tr> <td>Tsutomu NANATAKI</td> <td>11/19/2012</td> </tr> <tr> <td>Hirofumi YAMAGUCHI</td> <td>11/19/2012</td> </tr> </tbody> </table>		Name	Execution Date	Shinsuke YANO	11/19/2012	Takami HIRAI	11/23/2012	Tsutomu NANATAKI	11/19/2012	Hirofumi YAMAGUCHI	11/19/2012
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Tsutomu NANATAKI	11/19/2012										
Hirofumi YAMAGUCHI	11/19/2012										
RECEIVING PARTY DATA											
Name:	NGK Insulators, Ltd.										
Street Address:	2-56, Suda-Cho, Mizuho-Ku										
City:	Nagoya-Shi, Aichi-Prefecture										
State/Country:	JAPAN										
Postal Code:	467-8530										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13708174</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13708174						
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Application Number:	13708174										
CORRESPONDENCE DATA											
Fax Number:	3152338320										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone:	315-233-8300										
Email:	lvanantwerp@burrandbrown.com										
Correspondent Name:	BURR & BROWN										
Address Line 1:	PO BOX 7068										
Address Line 4:	SYRACUSE, NEW YORK 13261-7068										
ATTORNEY DOCKET NUMBER:	796_271										
NAME OF SUBMITTER:	Stephen P. Burr										
This document serves as an Oath/Declaration (37 CFR 1.63).											
Total Attachments: 2 source=Declaration-Assignment#page1.tif source=Declaration-Assignment#page2.tif											

CH \$40.00 13708174

**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION
USING AN APPLICATION DATA SHEET, AND ASSIGNMENT**

Title of Invention: 発明の名称 :	A circuit board for high-capacity modules, and a production method of the circuit board
<p>As the below named inventor, I hereby declare that:</p> <p>This declaration is directed to:</p> <p><input type="checkbox"/> The attached application, or</p> <p><input checked="" type="checkbox"/> United States application or PCT International Application Number <u>PCT/JP2011/078390</u> filed on <u>December 8, 2011</u>.</p> <p>The above identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p>	<p>私は、以下に記名された発明者として、ここに下記の通り宣言する：</p> <p>本宣言は以下に対するものである：</p> <p><input type="checkbox"/> 添付出願書または</p> <p><input type="checkbox"/> _____の日に提出された米国出願番号または PCT 国際出願番号 _____の出願書。</p> <p>上記の特定の出願は私または私の承認によって行われたものである。</p> <p>私は出願書において特許請求している発明の最初の発明者または最初の共同発明者であると信じている。</p> <p>私は本宣言における故意の虚偽の記載は米国法典第 18 編第 1001 条に基づき、罰金または五（５）年以下の懲役、もしくはその両方によって処罰されることがあることを承認する。</p>
<p>ASSIGNMENT: In consideration of the sum of one dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to</p>	<p>譲渡証： 各々の署名人に対して支払われた総額 1 ドル (\$ 1.00) および他の適切な有価約因を考慮して、本署名人（ら）は、</p>
<p>Name of Assignee: 譲受人の名前:</p> <p>Address of Assignee: 譲受人のアドレス:</p>	<p>NGK Insulators, Ltd.</p> <p>2-56, Suda-cho, Mizuho-ku, Nagoya-city, Aichi-ken 467-8530, Japan</p>
<p>(hereinafter designated as the Assignee) the entire right, title and interest for the United States, its territories, dependencies and possessions, in the invention, and all applications for patent and any Letters Patent which may be granted therefor for which the undersigned have executed an application</p>	<p>(以下、譲受人と称する)に対して、譲渡に同意し、本発明および特許のための全ての出願、署名人がアメリカ合衆国において特許出願を行い付与された全ての特許証における、アメリカ合衆国ならびにその領土、属領、財産のための全ての権利、所有権、および利権を</p>

for patent in the United States of America.	譲受人に移転および譲渡する。
Legal Name of Inventor/Assignor 発明者/譲渡人の氏名 Inventor/Assignor: <u>Shinsuke Yano</u> Date: <u>Nov. 19, 2012</u> Shinsuke YANO	
発明者/譲渡人: _____ 日付: _____	
Legal Name of Inventor/Assignor 発明者/譲渡人の氏名 Inventor/Assignor: <u>Takami Hirai</u> Date: <u>Nov. 23, 2012</u> Takami HIRAI	
発明者/譲渡人: _____ 日付: _____	
Legal Name of Inventor/Assignor 発明者/譲渡人の氏名 Inventor/Assignor: <u>Tsutomu Nanataki</u> Date: <u>Nov. 19, 2012</u> Tsutomu NANATAKI	
発明者/譲渡人: _____ 日付: _____	
Legal Name of Inventor/Assignor 発明者/譲渡人の氏名 Inventor/Assignor: <u>Hirofumi Yamaguchi</u> Date: <u>Nov. 19, 2012</u> Hirofumi YAMAGUCHI	
発明者/譲渡人: _____ 日付: _____	
Legal Name of Inventor/Assignor 発明者/譲渡人の氏名 Inventor/Assignor: _____ Date: _____ 発明者/譲渡人: _____ 日付: _____	
Legal Name of Inventor/Assignor 発明者/譲渡人の氏名 Inventor/Assignor: _____ Date: _____ 発明者/譲渡人: _____ 日付: _____	